

## Features

- ◆ Ultra low capacitance: 0.3pF typical (I/O to I/O)
- ◆ Ultra low leakage: nA level
- ◆ Low operating voltage: 5V
- ◆ Low clamping voltage
- ◆ Up to 4 data lines and one power line protects
- ◆ Complies with following standards:
  - IEC 61000-4-2 (ESD) immunity test  
Air discharge:  $\pm 25\text{kV}$   
Contact discharge:  $\pm 20\text{kV}$
  - IEC61000-4-4 (EFT) 40A (5/50ns)
  - IEC61000-4-5 (Lightning) : 4 A(8/20 $\mu\text{s}$ )
- ◆ ROHS Compliant

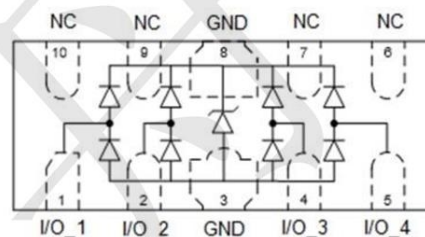
## Mechanical Characteristics

- ◆ Package: DFN2510-10 (2.5 $\times$ 1.0 $\times$ 0.5mm)
- ◆ Ultra low leakage: nA level
- ◆ Case Material: “Green” Molding Compound.
- ◆ UL Flammability Classification Rating 94V-0
- ◆ Moisture Sensitivity: Level 3 per J-STD-020
- ◆ Terminal Connections: See Diagram Below
- ◆ Shipping Qty :3000pcs/7Inch Tape & Reel

## Applications

- ◆ High Definition Multimedia Interface (HDMI)
- ◆ Digital Visual Interface (DVI)
- ◆ Unified Display Interface (UDI)
- ◆ MDDI Ports
- ◆ PCI Express
- ◆ Serial ATA

## Dimensions and Pin Configuration



**Marking: 5V40**

**Absolute Maximum Ratings** (Tamb=25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
Peak Pulse Power (8/20μs)	Ppk	80	W
Peak Pulse Current (8/20μs)	IPP	4	A
ESD per IEC 61000-4-2 (Air)	VESD	± 25	kV
ESD per IEC 61000-4-2 (Contact)		± 20	
Operating Temperature Range	TJ	-55 to +125	°C
Storage Temperature Range	Tstg	-55 to +150	°C

**Electrical Characteristics** (TA=25°C unless otherwise specified)

Parameter	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Working Voltage	VRWM			5	V	Any I/O pin to ground
Breakdown Voltage	VBR	7	8	9.5	V	IT = 1mA, any I/O pin to ground
Reverse Leakage Current	IR			0.1	μA	VRWM = 5V, any I/O pin to ground
Clamping Voltage	VC			9	V	IPP = 1A (8 x 20μs pulse), any I/O pin to ground
Clamping Voltage	VC			16	V	IPP = 4A (8 x 20μs pulse), any I/O pin to ground
Junction Capacitance	CJ		0.3	0.4	pF	VR = 0V, f = 1MHz, between I/O pins
Junction Capacitance	CJ			0.8	pF	VR = 0V, f = 1MHz, any I/O pin to ground

## Characteristic Curves

Fig1. 8/20 $\mu$ s Pulse Waveform

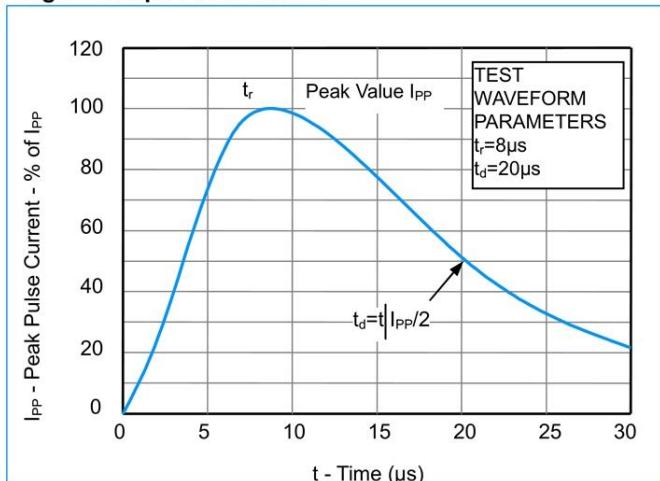


Fig2. ESD Pulse Waveform (according to IEC 61000-4-2)

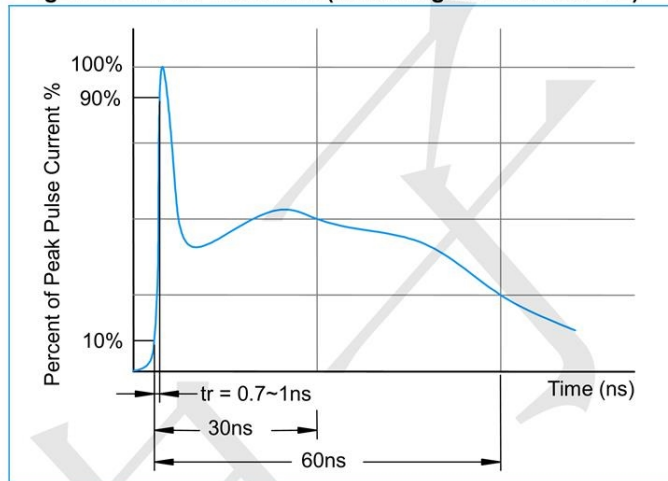
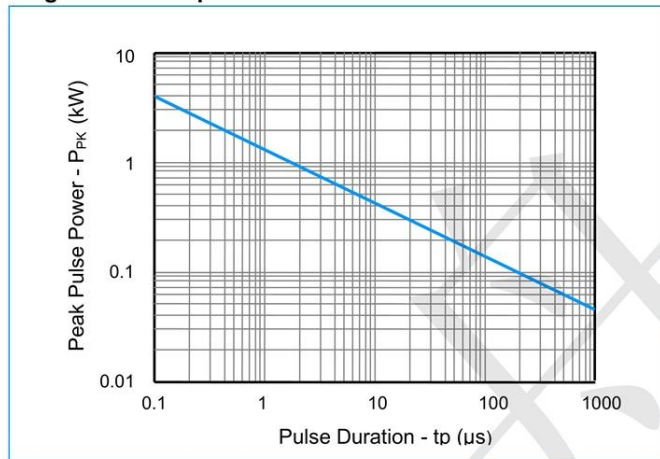
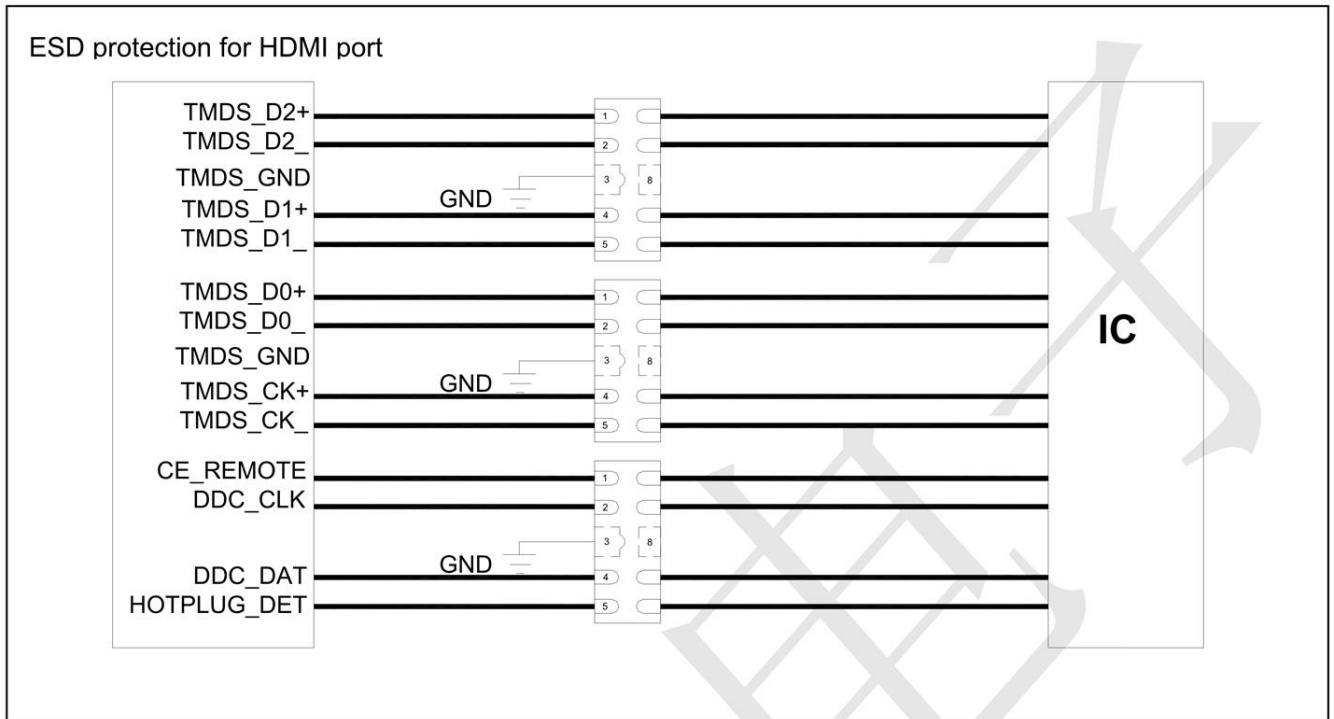


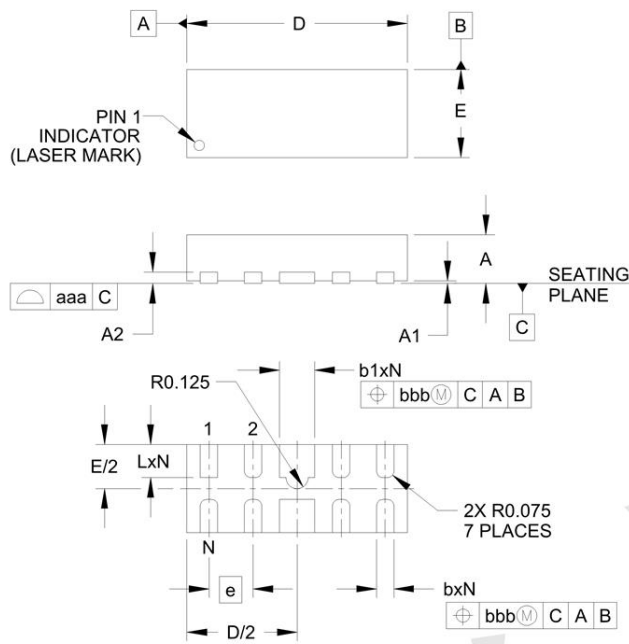
Fig3. Non - Repetitive Peak Pulse Power vs. Pulse Time



**Application Information**

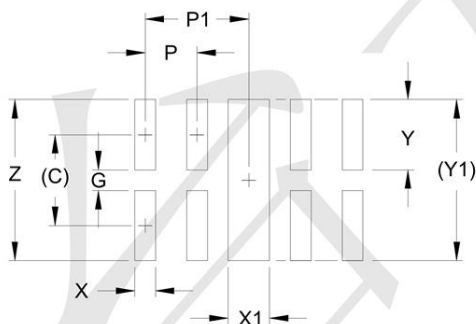


**Outline Drawing - DFN2510-10**



DIM	INCHES			MILLIMETERS		
	MIN	NOM	MAX	MIN	NOM	MAX
A	.020	.023	.026	0.50	0.58	0.65
A1	0.00	.001	.002	0.00	0.03	0.05
A2		(.005)			(0.13)	
b	.006	.008	.010	0.15	0.20	0.25
b1	.014	.016	.018	0.35	0.40	0.45
D	.094	.098	.102	2.40	2.50	2.60
E	.035	.039	.043	0.90	1.00	1.10
e		.020 BSC			0.50 BSC	
L	.012	.015	.017	0.30	0.38	0.425
N		8			8	
aaa		.003			0.08	
bbb		.004			0.10	

**Land Pattern - DFN2510-10**



DIM	DIMENSIONS	
	INCHES	MILLIMETERS
C	(.034)	(0.875)
G	.008	0.20
P	.020	0.50
P1	.039	1.00
X	.008	0.20
X1	.016	0.40
Y	.027	0.675
Y1	(.061)	(1.55)
Z	.061	1.55